

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Gwi-gyeon Yang	08/26/2008
RECEIVING PARTY DATA	
Name:	Fairchild Korea Semiconductor Ltd.
Street Address:	82-3, Dodang-dong, Wonmi-gu
City:	Bucheon-si, Gyeonggi-do
State/Country:	KOREA, REPUBLIC OF
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12284217
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ATTORNEY DOCKET NUMBER:	87908-748317 (029700US)
NAME OF SUBMITTER:	Hal R. Yeager
Total Attachments: 1 source=Assignment#page1.tif	

OP \$40.00 12284217

ASSIGNMENT OF PATENT APPLICATION

SOLE

WHEREAS, Gwi-gyeon Yang of 234-8, Deokpyeong-ri, Majang-myeon, Icheon-si, Gyeonggi-do, Republic of Korea, hereinafter referred to as "Assignor," is the inventor of the invention described and set forth in the below-identified application for United States Letters Patent:

Title of Invention: POWER DEVICE PACKAGE AND METHOD OF FABRICATING THE SAME

Date(s) of Execution: August 26, 2008

Filing Date: September 18, 2008

Application No.: 12/284,217; and

WHEREAS, Fairchild Korea Semiconductor Ltd., located at 82-3, Dodang-dong, Wonmi-gu, Bucheon-si, Gyeonggi-do, Korea, hereinafter referred to as "ASSIGNEE," is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has sold, assigned and transferred, and by these presents does sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all their right, title and interest in and to said invention and application, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees that Assignor will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

Assignor hereby authorizes and requests Townsend and Townsend and Crew LLP, Two Embarcadero Center, Eighth Floor, San Francisco, CA 94111-3834, to insert herein above the application number and filing date of said application when known.

IN TESTIMONY WHEREOF, Assignor has signed his/her name on the date indicated.

Dated: 2008. 8. 26

Yang
Gwi-gyeon Yang